

# **SMP-TPS7A3001-MVK User's Guide**

## **User's Guide**



Literature Number: SLVU665  
April 2012

|          |                                                    |           |
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## **SMP-TPS7A3001-MVK User's Guide**

### **1 Introduction**

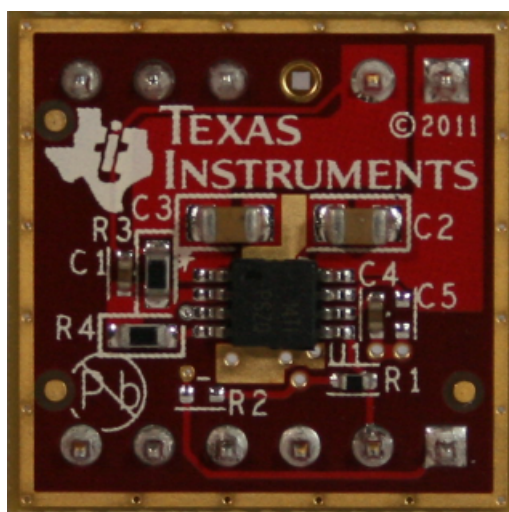
This document discusses the Modular and Versatile Reference Kit (MAVRK) [TPS7A3001](#) negative voltage low-dropout linear regulator (LDO) submodule. After reading this guide, a developer should understand the features of the [SMP-TPS7A3001-MVK](#). For more information on the MAVRK system, see the [MAVRK Introduction page](#).

### **2 EVM Overview**

The [SMP-TPS7A3001-MVK](#) highlights the [TPS7A3001](#) negative voltage, ultralow noise, high PSRR LDO. This submodule is intended to convert  $-3$  to  $-36$  V DC to voltages down to  $-1.18$  V on [MAVRK PMU](#) modules, such as the [PMU-CARRIER-MVK](#) and [PMU-BAT-MVK](#). The default output voltage for this module is  $-2.5$  V DC.

#### **2.1 EVM Description**

[Figure 1](#) shows the SMP-TPS7A3001-MVK submodule.



**Figure 1. SMP-TPS7A3001-MVK Submodule**

The [SMP-TPS7A3001-MVK](#) contains the [TPS7A3001](#) integrated circuit and all other onboard components necessary to generate  $-2.5$  V from a source of up to  $-36$  V. The [SMP-TPS7A3001-MVK](#) can be used with a [MAVRK PMU](#) carrier board to evaluate the [TPS7A3001](#) performance as part of a power-management system. An onboard I<sup>2</sup>C™ temperature sensor can report the board temperature to the carrier board.

## 2.2 Features

### 2.2.1 TPS7A3001

- Input voltage range: –3 V to –36 V
- Noise:
  - 14  $\mu$ VRMS (20 Hz to 20 kHz)
  - 15.1  $\mu$ VRMS (10 Hz to 100 kHz)
- Power-supply ripple rejection:
  - 72 dB (120 Hz)
  - $\geq$  55 dB (10 Hz to 700 kHz)
- Adjustable output: –1.18 V to –33 V
- Maximum output current: 200 mA
- Dropout voltage: 216 mV at 100 mA
- Stable with ceramic capacitors  $\geq$  2.2  $\mu$ F
- CMOS logic-level-compatible enable pin
- Built-in, fixed current limit and thermal shutdown protection
- Available in high thermal performance MSOP-8 PowerPAD™ package
- Operating temperature range: –40°C to 125°C

### 2.2.2 SMP-TPS7A3001-MVK

- Default –2.5 V output
- Onboard [TMP103](#) I<sup>2</sup>C temperature sensor
- Compatible with [MAVRK PMU](#) carrier boards
- Breadboard compatible with 0.1-inch headers

## 2.3 Featured Applications

The [SMP-TPS7A3001-MVK](#) MAVRK submodule can be used on the following applications:

- Supply rails for operational amplifiers, DACs, ADCs, and other high-precision analog circuitry
- Audio
- Post DC-DC converter regulation and ripple filtering
- Test and measurement
- RX, TX, and PA circuitry
- Industrial instrumentation
- Base stations and telecom infrastructure
- –12 V and –24 V industrial buses

## 2.4 Highlighted Products

The [SMP-TPS7A3001-MVK](#) submodule highlights the following devices:

- [TPS7A3001 –3 to –36-V input, –200 mA, ultralow noise, high PSRR, LDO](#)
- [TMP103 digital temperature sensor with I2C/SMBUS expanded interface](#)

## 2.5 Block Diagram

Figure 2 shows the SMP-TPS7A3001-MVK block diagram.

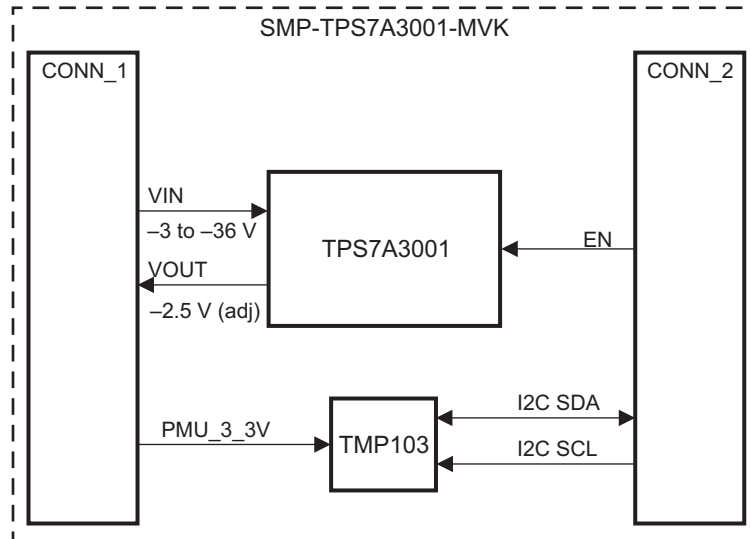


Figure 2. SMP-TPS7A3001-MVK Block Diagram

## 2.6 EVM Wiki

The most up-to-date information on this module is located on the [SMP-TPS7A3001-MVK MAVRK submodule wiki page](#).

## 2.7 EVM Landing Page

Ordering information and availability of this module is located on the [SMP-TPS7A3001-MVK MAVRK submodule tool folder](#).

# 3 Hardware Description

## 3.1 Power Requirements

The [SMP-TPS7A3001-MVK](#) can accept an input of -3 to -36 V from the carrier board. By default, the [SMP-TPS7A3001-MVK](#) generates -2.5 V on the output. The output voltage can be modified by adjusting feedback resistors  $R_3$  and  $R_4$ , as shown in [Equation 1](#).

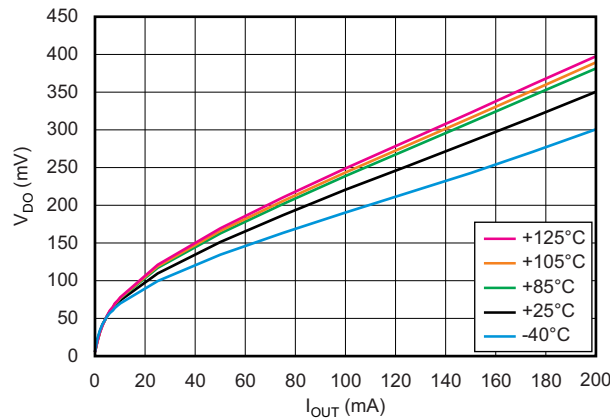
$$R_3 = R_4 \left( \frac{V_{OUT}}{V_{REF}} - 1 \right) \quad (1)$$

Where  $V_{REF} = -1.184$  V.

To ensure stability under no-load conditions, this resistive network must provide a current equal to or greater than 5 mA.

$$\left( \frac{V_{OUT}}{R_3 + R_4} \right) \geq 5 \mu A \quad (2)$$

To maintain regulation, the input voltage must be more negative than the negative output voltage minus the dropout voltage of the LDO, shown in [Figure 3](#).



**Figure 3. TPS7A3001 Dropout Voltage Versus Output Current**

The output current of the SMP-TPS7A3001-MVK must not exceed 200 mA. Due to the small PCB area of the submodule, it is recommended not to exceed 0.75 W of power consumption on the board. The power consumption can be estimated as  $(V_{IN} - V_{OUT}) \times I_{OUT}$ . The onboard temperature sensor can measure the temperature rise at different power levels.

The [SMP-TPS7A3001-MVK](#) can be used in a breadboard if pin 4 of CONN\_1 (PMU\_3\_3V) is tied to a pullup voltage within the enable (EN) voltage range of the device. To avoid damage to the onboard temperature sensor, this voltage must not exceed 3.6 V. For connector pinout information, see the [Hardware Design Guide for MAVRK PMU DC-DC Submodule](#).

### 3.2 Connector Signal Descriptions

For information about the [SMP-TPS7A3001-MVK](#) connector pinouts, see the [Hardware Design Guide for MAVRK PMU DC-DC Modules](#).

### 3.3 Getting Started: Configuring the EVM

The [SMP-TPS7A3001-MVK](#) should be connected to a DC-DC converter slot with negative voltage support on a [PMU-CARRIER-MVK](#) carrier board, such as the [PMU-CARRIER-MVK](#). The carrier board voltage and current limits must not be exceeded when using this module. For detailed setup information, see the [Configuring Power Submodules on a PMU Carrier Board](#) page.

## 4 Board Files

### 4.1 Bill of Materials (BOM)

[Download PDF](#) of the bill of materials.

**Table 1. SMP-TPS7A3001-MVK Bill of Materials**

| Item | Quantity | Reference Designator | Value            | Part Description                                                                                         | Temperature °C | Manufacturer       | Manufacturer Part Number |
|------|----------|----------------------|------------------|----------------------------------------------------------------------------------------------------------|----------------|--------------------|--------------------------|
| 1    | 1        | C1                   | 10 nF            | Capacitor, Ceramic, 10 nF, 25 V, ±10%, X7R, 0402                                                         | –55 to 125     | Taiyo Yuden        | TMK105B7103KV-F          |
| 2    | 2        | C2 C3                | 10 uF            | Capacitor, Ceramic, 10 uF, 25 V, ±10%, X5R, 0805                                                         | –55 to 85      | Murata Electronics | GRM21BR61E106KA73L       |
| 3    | 1        | C4                   | 10 nF            | Capacitor, Ceramic, 10 nF, 25 V, ±10%, X7R, 0402                                                         | –55 to 125     | Taiyo Yuden        | TMK105B7103KV-F          |
| 4    | 0        | C5                   | 0.001 uF         | Capacitor, Ceramic, 1000 pF, 50 V, C0G, 0402                                                             | –55 to 125     | Murata Electronics | GRM1555C1H102JA01D       |
| 5    | 1        | C6                   | 10 nF            | Capacitor, Ceramic, 10 nF, 2 5 V, ±10%, X7R, 0402                                                        | –55 to 125     | Taiyo Yuden        | TMK105B7103KV-F          |
| 6    | 1        | CONN_1               | 1x6              | High temp, 0.100-inch-pitch, 1x6, Overall 430L Post Gold, Single, 230 Post height Pin three is polarized | –55 to 125     | Samtec             | HMTSW-106-07-G-S-230-003 |
| 7    | 1        | CONN_2               | 1x6              | High temp, 0.100-inch pitch, 1x6, Overall 430L Post Gold, Single, 230 Post height                        | –55 to 125     | Samtec             | HMTSW-106-07-G-S-230     |
| 8    | 1        | R1                   | 10 kΩ            | Resistor, thick film, 10 kΩ, 0.1 W, ±200ppm/°C, ±5%, 0402                                                | ±200 ppm/°C    | Panasonic - ECG    | ERJ-2GEJ103X             |
| 9    | 0        | R2                   | 10 kΩ            | Resistor, thick film, 10 kΩ, 0.1W, ±200ppm/°C ±5%, 0402                                                  | ±200 ppm/°C    | Panasonic - ECG    | ERJ-2GEJ103X             |
| 10   | 0        | R3                   | 200 kΩ           | Resistor, thick film, 200 kΩ, 0.1 W, ±100ppm/°C, ±1%, 0603                                               | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF2003V            |
| 11   | 0        | R4                   | 113 kΩ           | Resistor, thick film, 113 kΩ, 0.1W, ±100ppm/°C, ±1%, 0603                                                | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF1133V            |
| 12   | 1        | U2                   | ADDR = 1110000   | IC TEMP SENSOR DGTL SMBUS 4DSBGA - ADDR=1110000                                                          | –10 to 100     | Texas Instruments  | TMP103AYFF               |
| 13   | 1        | R3                   | 147 kΩ           | Resistor, thick film, 147 kΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                              | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF1473V            |
| 14   | 1        | R4                   | 133 kΩ           | Resistor, thick film, 133 kΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                              | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF1333V            |
| 15   | 0        | R3                   | 475 kΩ           | Resistor, thick film, 475 kΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                              | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF4753V            |
| 16   | 0        | R4                   | 51.1 kΩ          | Resistor, thick film, 51.1 kΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                             | ±100 ppm/°C    | Panasonic - ECG    | ERJ-3EKF5112V            |
| 17   | 1        | LB1                  | Line 1<br>Line 2 | SMP-TPS7A3001-MVK<br>BOM REV C                                                                           |                | Brady              | THT-14-423-10            |
| 18   | 1        | U1                   | TPS7A3001DGN     | IC REG LDO ADJ –1.18 V to –33 V 200 mA 8MSOP                                                             | –40 to 125     | Texas Instruments  | TPS7A3001DGN             |
| 19   | 0        | R3                   | 1.5 MΩ           | Resistor, thick film, 1.5 MΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                              | ±100 ppm/°C    | Vishay/Dale        | CRCW06031M50FKEA         |
| 20   | 0        | R4                   | 1.37 MΩ          | Resistor, thick film, 1.37 MΩ, 0.1 W, ±100 ppm/°C, ±1%, 0603                                             | ±100 ppm/°C    | Vishay/Dale        | CRCW06031M37FKEA         |

## 4.2 Layout (PDF)

[Download PDF](#) of additional board layers.

Figure 4 through Figure 13 show the separate SMP-TPS7A3001-MVK board layers.

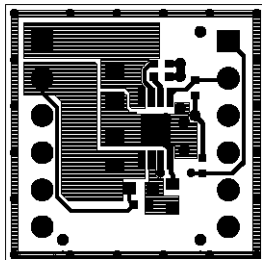


Figure 4. SMP-TPS7A3001-MVK Board Layer 1 – Top Side

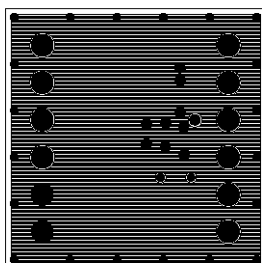


Figure 5. SMP-TPS7A3001-MVK Board Layer 2 – Ground Plane

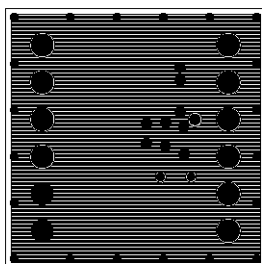


Figure 6. SMP-TPS7A3001-MVK Board Layer 3 – Top Side

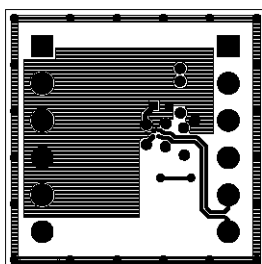


Figure 7. SMP-TPS7A3001-MVK Board Layer 4 – Bottom Side

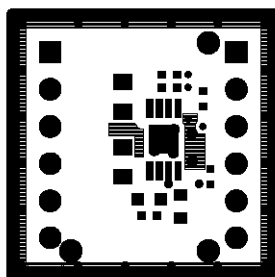


Figure 8. SMP-TPS7A3001-MVK Board Solder Mask – Top Side

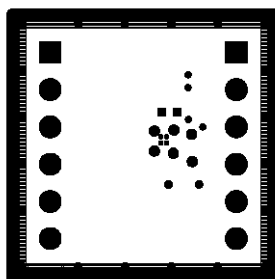


Figure 9. SMP-TPS7A3001-MVK Board Solder Mask – Bottom Side

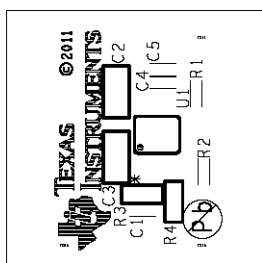


Figure 10. SMP-TPS7A3001-MVK Board Silkscreen – Bottom Side

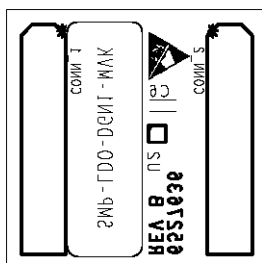
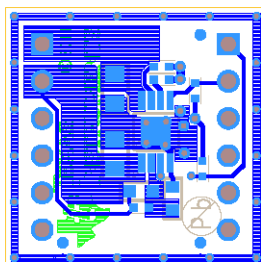
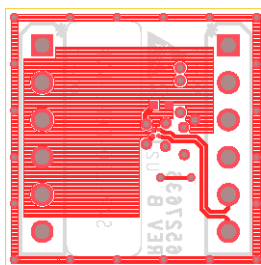


Figure 11. SMP-TPS7A3001-MVK Board Silkscreen – Bottom Side



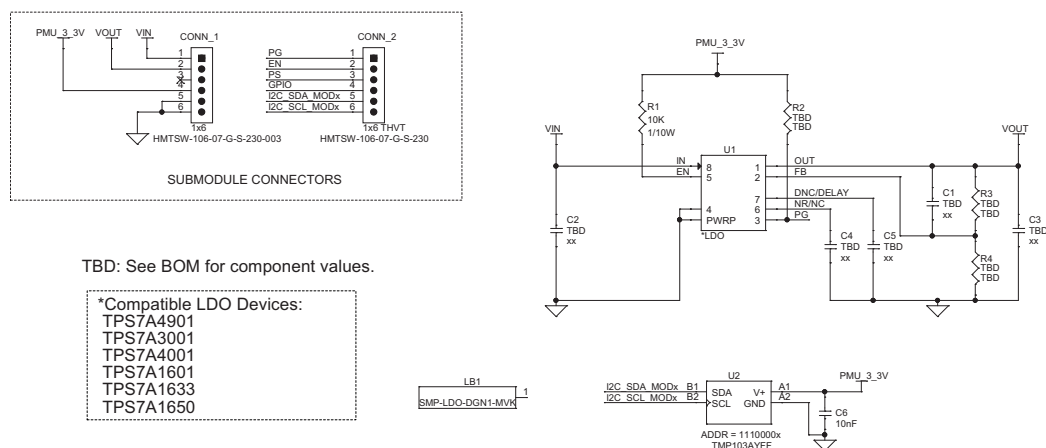
**Figure 12. SMP-TPS7A3001-MVK Board Layer 1 – Top Side**



**Figure 13. SMP-TPS7A3001-MVK Board Layer 4 – Bottom Side**

### 4.3 Schematics (PDF)

[Download PDF](#) of the schematic.

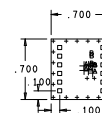
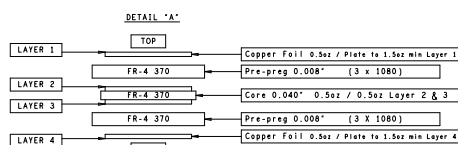


**Figure 14. SMP-TPS7A3001-MVK Schematic**

## 4.4 Fabrication Drawings (PDF)

[Download PDF](#) of the fabrication drawing.

- UNLESS OTHERWISE SPECIFIED, ALL NOTES ARE APPLICABLE.  
NOTES PRECEDED BY AN UNMARKED ☐ ARE NOT APPLICABLE.
1. ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE NOTED.
  2. PCB SHALL BE FABRICATED TO IPC-6012, CLASS II AND WORKMANSHIP SHALL CONFORM TO IPC-600, CLASS II CURRENT REVISIONS.
  3. MINIMUM COPPER WALL THICKNESS SHALL BE .001 INCH. FOR ALL PLATED THROUGH HOLES.
  4. BOARD MATERIAL SHALL BE 1801g 370HR OR EQUIVALENT. BOARD SHALL MEET OR EXCEED IPC-4101/26. COLOR: NATURAL.
  5. BOARD MATERIAL AND CONSTRUCTION TO BE UL 94V-0 APPROVED AND MARKED ON THE FINISHED BOARD.
  6. OVERALL BOARD THICKNESS TO BE .062 +/- .005 AND APPLIES AFTER ALL LAMINATION AND PLATING PROCESSES. MEASURED FROM COPPER TO COPPER.  
☐ MANUFACTURE'S UL MARKING, FLAMMABILITY RATING, ☐ LOGO AND DATE CODE
  7. TO BE PLACED IN COPPER ON BOTTOM SIDE OF THE BOARD.
  8. PLATE ALL EXPOSED AREAS WITH ELECTROLESS NICKEL IMMERSION GOLD, NICKEL: 100 MICRO-INCHES MIN. GOLD: 2-8 MICRO-INCHES MIN
  9. APPLY LPI SOLDERMASK OVER BARE COPPER (SMBRC)  
COLOR: RED  
SOLDERMASK SHALL CONFORM TO IPC-SM-840 CLASS H, CURRENT REVISION
  10. SOLDERMASK ARTWORK HAS ZERO (0) OVERSIZED PADS.  
FABRICATION VENDOR IS ALLOWED TO ADJUST THE COMPONENT SOLDERMASK PADS TO MEET THEIR TOOLING REQUIREMENTS.
  11. SILKSCREEN-APPLY NON-CONDUCTIVE LPI OR EQUIVALENT PER THE ARTWORK  
COLOR: WHITE
  12. P.C.B. BOARD TO BE FREE OF DIRT, OIL, FINGER PRINTS, ETC.
  13. BOARD WARPAGE: WARP AND TWIST SHALL NOT EXCEED .0075 INCH PER INCH MEASURED AT ANY LOCATION OR DIRECTION ON THE BOARD.
  14. ☒ BOARD MUST BE ELECTRICALLY TESTED USING SUPPLIED IPC-D-354 NETLIST.



VIEWED FROM TOP(Layer 1) SIDE

| DRILL CHART: TOP to BOTTOM |      |           |        |     |
|----------------------------|------|-----------|--------|-----|
| ALL UNITS ARE IN MILS      |      |           |        |     |
| FIGURE                     | SIZE | TOLERANCE | PLATED | QTY |
| +                          | 10.0 | +3.0/-3.0 | PLATED | 22  |
| +                          | 12.0 | +3.0/-3.0 | PLATED | 6   |
| +                          | 14.0 | +3.0/-3.0 | PLATED | 4   |
| +                          | 38.0 | +3.0/-3.0 | PLATED | 12  |

Figure 15. SMP-TPS7A3001-MVK Fabrication Drawing

## 4.5 Gerber Files

[Download a ZIP](#) of the Gerber files.

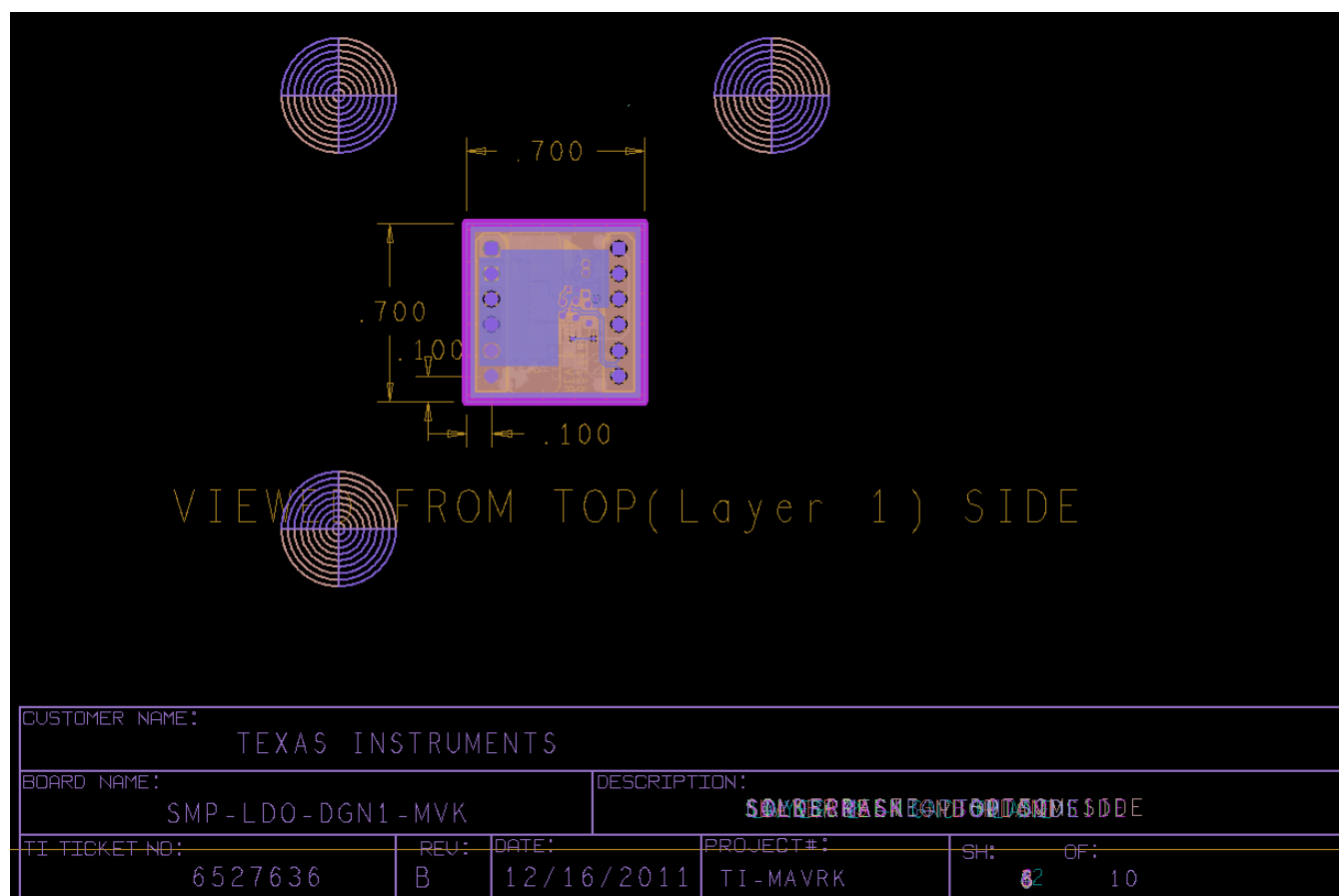


Figure 16. SMP-TPS7A3001-MVK Gerber Files

## 4.6 Cadence Schematic and Board Files

[Download a ZIP](#) of the Cadence schematic and board files.

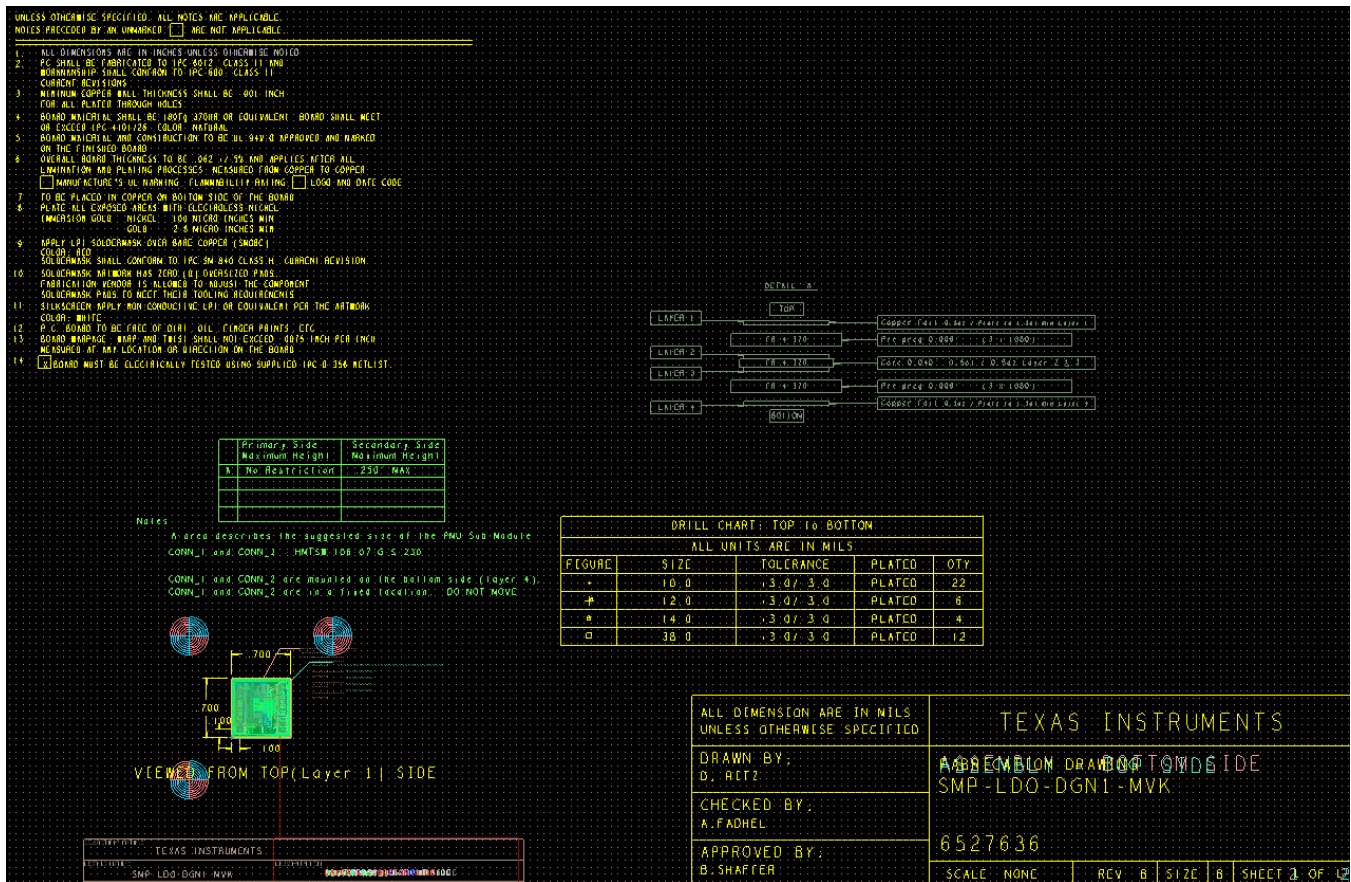


Figure 17. SMP-TPS7A3001-MVK Cadence Schematic and Board Files

## 5 Precautions and Certifications

### 5.1 ESD Precautions

The following guidelines should be followed to avoid ESD damage to the board components:

- Any person handling boards must be grounded either with a wrist strap or ESD protective footwear, used in conjunction with a conductive or static-dissipative floor or floor mat.
- The work surface where boards are placed for handling, processing, testing, and so forth, must be made of static-dissipative material and be grounded to ESD ground.
- All insulator materials either must be removed from the work area or neutralized with an ionizer. Static-generating clothes should be covered with an ESD-protective smock.
- When boards are being stored, transferred between operations or workstations, or shipped, they must be maintained in a Faraday-shield container whose inside surface (touching the boards) is static dissipative.

### 5.2 Certifications

[FCC and ICES standard EMC test report for the SMP-TPS7A3001-MVK submodule, aboard the MB-PRO-MVK motherboard](#)

[Eco-Info & Lead-Free Home](#)

[RoHS-Compliant Solutions](#)

[Statement on Registration, Evaluation, Authorization of Chemicals \(REACH\)](#)

## 6 MAVRK Links

### 6.1 Additional Information on MAVRK

Visit the [MAVRK wiki pages](#) to get comprehensive information on MAVRK.

### 6.2 MAVRK Questions

Post any questions on the [MAVRK Forum](#).

### 6.3 Additional Technical Information on MAVRK Hardware

Review the wiki pages related to [designing MAVRK hardware](#).

### 6.4 Additional Technical Information on MAVRK Software

Review the wiki pages related to [working with MAVRK software](#).

### 6.5 Obtaining a MAVRK Board

See the [MAVRK Starter Kit tool folder page](#) to order a MAVRK starter kit. To order other modules, search for them by name on the [TI Web site](#) to find their tool folder pages.

## EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit [www.ti.com/esh](http://www.ti.com/esh) or contact TI.

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## REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

### General Statement for EVMs including a radio

*User Power/Frequency Use Obligations:* This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

### For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

#### Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

**FCC Interference Statement for Class B EVM devices**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

**For EVMs annotated as IC – INDUSTRY CANADA Compliant**

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

**Concerning EVMs including radio transmitters**

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

**Concerning EVMs including detachable antennas**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

**Concernant les EVMs avec appareils radio**

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

**Concernant les EVMs avec antennes détachables**

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

## **【Important Notice for Users of this Product in Japan】**

**This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan**

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

**Texas Instruments Japan Limited**  
**(address) 24-1, Nishi-Shinjuku 6 chome, Shinjuku-ku, Tokyo, Japan**

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## EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS

**For Feasibility Evaluation Only, in Laboratory/Development Environments.** Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

**Certain Instructions.** It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

**Agreement to Defend, Indemnify and Hold Harmless.** You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

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